

	Hits	Search Text	DBs	Time Stamp
1	0	"200500223656"	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/05/15 08:59
2	2	"20050223656"	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/05/15 08:59
3	2	"20050023656"	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/05/15 09:00
4	78	("3636358" "39329324028547" "4393127" "4528072" "4566037" "4604162" "4622632" "4810889" "4849857" "4928058" "4990462" "5051326" "5110712" "5119164" "5166962" "5169805" "5188706" "5245277" "5283107" "5284804" "5293457" "5399505" "5423999" "5450603" "5470693" "5517457" "5572689" "5577050" "5615163" "5745673" "5786629" "5818748" "6092174" "6154809" "6301653" "6300935" "6320593" "6355976" "6894392") .pn.	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/05/15 09:37
5	464	monolithic adj (substrate substrates) and flex\$4	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/05/15 09:39
6	77	monolithic adj (substrate substrates) and flex\$4 near2 (substrate substrates)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/05/15 09:40
7	41	monolithic adj (substrate substrates) and flex\$4 near2 (substrate substrates) and (bond bonding bonded)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/05/15 09:50

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8	28	monolithic adj (substrate substrates) and flex\$4 near2 (substrate substrates) and (bond bonding bonded) with (substrate substrates)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/05/15 09:47
9	3	monolithic adj (substrate substrates) same flex\$4 near2 (substrate substrates) and (bond bonding bonded) with (substrate substrates)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/05/15 09:45
10	2	monolithic adj (substrate substrates) and flex\$4 near2 (substrate substrates) and (bond bonding bonded) near2 substrates	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/05/15 09:46
11	21	monolithic adj (substrate substrates) and flex\$4 near2 (substrate substrates) and (bond bonding bonded) near3 (substrate substrates)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/05/15 09:47
12	5	monolithic adj (substrate substrates) same flex\$4 near2 (substrate substrates) and (bond bonding bonded)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/05/15 09:50
13	0	active adj (circuit circuity) same reconfiguration adj (circuit circuity) same passive adj (circuit circuity) same (substrate die)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/05/15 10:00
14	0	active near2 (circuit circuity) same reconfiguration near2 (circuit circuity) same passive near2 (circuit circuity) same (substrate die)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/05/15 10:01
15	0	active same reconfiguration same passive same (circuit circuity) same (substrate die)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/05/15 10:01
16	1	active near2 (circuit circuity) and reconfiguration near2 (circuit circuity) and passive near2 (circuit circuity) same (substrate die)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/05/15 10:01

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17	1	active near2 (circuit circuity) and reconfiguration near2 (circuit circuity) and passive near2 (circuit circuity)	US - PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/05/15 10:01